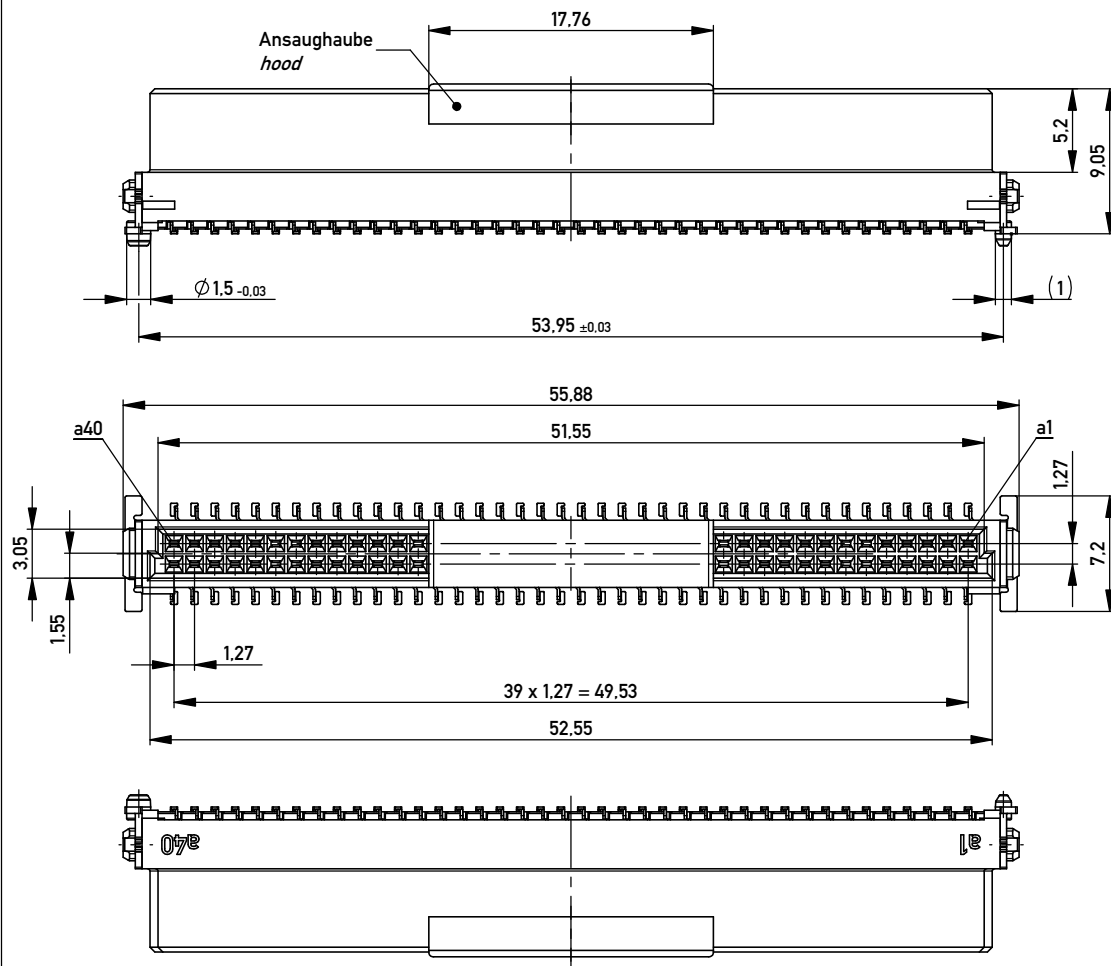
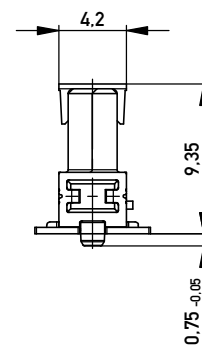
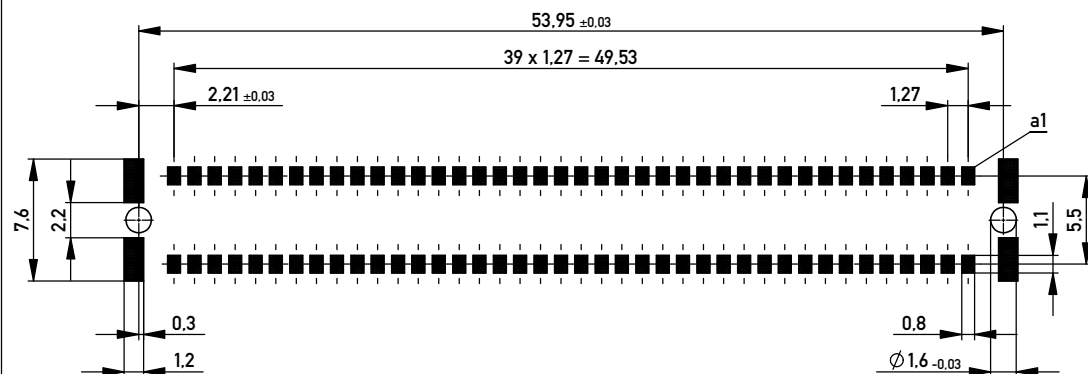
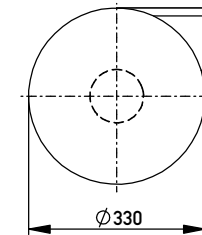




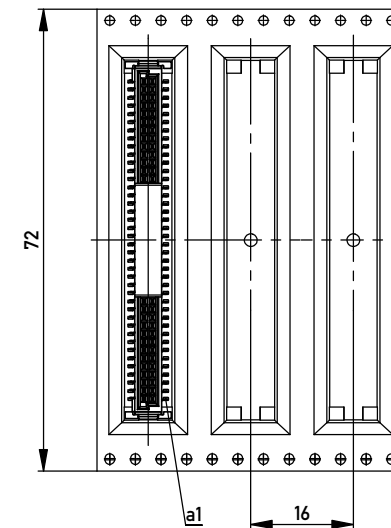
Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 280 Stück
Packaging unit: 280 pcs



Abspulrichtung - Reel off Direction



Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0.1 mm
Coplanarity Area of Termination ≤ 0.1 mm

BA 7-03 - Standard Bauhöhe

type 7-03 - standard assembly height

Information:		Tolerances	Scale 3:1		
All rights reserved. Only for Information. To ensure that this is the latest version of this drawing, please contact one of the ERNI companies before using.		Subject to modification without prior notice. Drawing will not be updated.	Designation		
e		10.12.2013	Date		
Index		Date			
ERNI		www.ERNI.com			
154721		Class		SMCB	
				I	
				A3	